

NOT RECOMMENDED FOR NEW DESIGN USE <u>AH3774</u>

Pin Assignments



AH3761

HIGH SENSITIVITY HALL EFFECT LATCH

⊐ 3. OUT

□ 2. GND

1. Vdd

OUT

Vdd

(Top View)

SIP-3 (Bulk Pack)

SC59

(Top View

GND 2.

Brush-less DC Motor Commutation

Consumer and Industrial Position Sensor

Description

The AH3761 is an integrated Hall effect latched sensor designed for electronic commutation of brush-less DC motor applications. The device includes an on-chip Hall voltage generator for magnetic sensing, a comparator that amplifies the Hall voltage, and a schmitt trigger to provide switching hysteresis for noise rejection, and open drain output. An internal bandgap regulator is used to provide temperature compensated supply voltage for internal circuits and allows a wide operating supply range.

If a magnetic flux density larger than threshold Bop, DO is turned on (low). The output state is held until a magnetic flux density reversal falls below Brp causing DO to be turned off (high).

Features

- 3V to 28V DC Operation Voltage
- Chopper Stabilized
- Wide Operating Voltage Range
- Built-in Power Reverse Protection
- Built-in Voltage Overshoot Protection
- Output Short Circuit Protection
- Open Drain Pre-Driver
- SIP-3 (Ammo Pack), SIP-3 (Bulk Pack) and SC59 (Commonly known as SOT23 in Asia)
- Available in "Green" Molding Compound (No Br, Sb)
- Totally Lead-Free & Fully RoHS Compliant (Note 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Notes:

Flow Meters

Applications

RPM Detection

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 - See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and
 - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Typical Applications Circuit





Pin Descriptions

Pin Name	n Name P/I/O Pin #		Description
Vdd	Р	1	Positive Power Supply
GND	Р	2	Ground
OUT	0	3	Output Pin



Absolute Maximum Ratings (T_A = +25°C)

Symbol	Characterist	ics	Values	Unit			
V _{DD}	Supply Voltage		30	V			
V _{RDD}	Reverse Battery Voltage		-30	V			
В	Magnetic Flux Density		Unlimited				
VDS	Output OFF Voltage	30	V				
I _{O(peak)}	Output "On" Current (Peak)	100	mA				
T _{ST}	Storage Temperature Range	Storage Temperature Range					
TJ(MAX)	Maximum Junction Temperature	Maximum Junction Temperature					
PD	Package Power Dissipation	SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)	550	mW			
b		SC59	230	mW			
θյς	Thermal Resistance Junction to case	SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)	227	°C/W			
		SC59	543	°C/W			



Recommended Operating Conditions

Symbol	Characteristic	Characteristic Conditions		Тур.	Max	Unit
V _{DD}	Supply Voltage	Operating	3	24	28	V
T _A	Operating Ambient Temperature	Operating	-40	-	+125	°C

Electrical Characteristics (T_A = +25°C, V_{DD} =24V, Note 4)

Symbol	Characteristic	Test Conditions	Min	Тур.	Max	Unit
V _{O(SAT)}	Output Saturation Voltage	lout =20mA, B>Bop	-	300	500	mV
IOFF	Output Leakage Current	V _O =24V, B <bop< td=""><td></td><td>< 0.1</td><td>10</td><td>μA</td></bop<>		< 0.1	10	μA
I _{DD}	Supply Current	Output Open	-	4	6	mA
t _R	Output Rising Time	$R_L = 10k\Omega$, $C_L = 16pF$		340	-	ns
t _F	Output Falling Time	$R_L = 10k\Omega$, $C_L = 16pF$		20	-	ns
fc	Chopping Frequency	-	-	300	-	kHz
IOM	Output Current Limit	B>Bop (Note 5)	50	70	90	mA
ts⊤	Start-up time of IC	V _{DD} >3V, B>Bop (Note 6)		47	-	μs

Notes: 4. Typical data is at T_A =+25°C, V_{DD} =24V and is design information only.

5. The device will shut down operating after the output current I_O is over the output current limit I_{OM} for 160µs (typically). The device will re-start up operating after resetting the supply voltage V_{DD}.

6. In initial power on time, the output state is kept in "High" in this start-up time of IC.

Magnetic Characteristics (T_A = +25°C, V_{DD} =3V to 28V, Note 7)

				(1mT=10Gauss)
Symbol	Parameter	Min	Тур.	Max	Unit
Вор	Operate Point	5	30	60	Gauss
Brp	Release Point	-60	-30	-5	Gauss
Bhys	Hysteresis	-	60	-	Gauss

Notes: 7. Magnetic characteristics are for design information, which will vary with supply voltage, operating temperature and after soldering.





Performance Characteristics

(1) SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)

T _A (°C)	25	50	60	70	80	85	90	95	100
P _D (mW)	550	440	396	352	308	286	264	242	220
T _A (°C)	105	110	115	120	125	130	135	140	150
P _D (mW)	198	176	154	132	110	88	66	44	0



Power Dissipation Curve



(2) SC59 (Commonly known as SOT23 in Asia)

T _A (°C)	25	50	60	70	80	90	100	110	120	125	130	140	150
P _D (mW)	230	184	166	147	129	110	92	74	55	46	37	18	0





Ordering Information



				Βι	ılk	7" Tape	and Reel	👞 Ammo Box	
Device	Status (Note 11)	Package Code	Packaging (Note 8)	Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH3761-PG-A	NRND	Р	SIP-3(Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3761-PG-B	NRND	Р	SIP-3(Bulk Pack)	1000	-В	NA	NA	NA	NA
AH3761-WG-7	NRND	W	SC59	NA	NA	3000/Tape & Reel	-7	NA	NA

8. Pad layout as shown on Diodes Incorporated's suggested pad layout document, which can be found on our website at http://www.diodes.com/package-outlines.html.
9. Ammo Box is for SIP-3 Spread Lead.
10. Bulk is for SIP-3 Straight Lead.
11. NRND = Not Recommended for New Design. Notes:



Marking Information

(1) Package Type: SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)





Package Outline Dimensions (All Dimensions in mm)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SIP-3 (Bulk Pack)





Package Outline Dimensions (Cont.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(2) Package Type: SIP-3 (Ammo Pack)





Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SC59



Dimensions	Value (in mm)	
Z	3.4	
Х	0.8	
Y	1.0	
С	2.4	
E	1.35	

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